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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/815,287	04/01/2004	Soon-Il Ahn	8054-57 (LW9035US/KE) 8332	
22150 F CHAIL& A	7590 01/28/2008 SSOCIATES, LLC		EXAMINER	
130 WOODBU	JRY ROAD		PERKINS, PAMELA E	
WOODBURY	, NY 11797		ART UNIT PAPER NUMBER 2822	
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			MAIL DATE	DELIVERY MODE
			01/28/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application No.	Applicant(s)
		10/815,287	AHN ET AL.
Office Action Summary		Examiner	Art Unit
		Pamela E. Perkins	2822
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the	correspondence address
A SH WHIC - Exter after - If NC - Failu Any (ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATES and the may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. It is period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tirg will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. mely filed the mailing date of this communication. ED (35 U.S.C. § 133).
Status			
2a)□	Responsive to communication(s) filed on <u>30 Au</u> This action is FINAL . 2b) This Since this application is in condition for allowant closed in accordance with the practice under E	action is non-final.	
Dispositi	on of Claims		
5) □ 6) ☑ 7) □ 8) □	Claim(s) 1-9 and 11-24 is/are pending in the ap 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 1-9 and 11-24 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or on Papers	vn from consideration.	
10)[The specification is objected to by the Examiner The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the o Replacement drawing sheet(s) including the correcti The oath or declaration is objected to by the Example.	epted or b) objected to by the drawing(s) be held in abeyance. Se on is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).
Priority u	ınder 35 U.S.C. § 119		
a)[Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau see the attached detailed Office action for a list of	s have been received. s have been received in Applicati ity documents have been receive (PCT Rule 17.2(a)).	ion No ed in this National Stage
2) D Notic 3) D Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Do 5) Notice of Informal F 6) Other:	ate

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DETAILED ACTION

This office action is in response to the filing of the request for reconsideration on 30 August 2007. Claims 1-9, 11-24 are pending; claim 10 has been cancelled.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Makinouchi (5,677,754).

Makinouchi disclose a method for exposing a layer with a light where a mask including a pattern shape is disposed over the layer formed on a substrate; and scanning the mask with the light, such that a direction of the scanning is substantially perpendicular to a longitudinal direction of the pattern shape to form a pattern (Fig. 1 & 2a; col. 3, lines 4-20; col. 5, lines 15-39; col. 7, lines 34-48).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

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invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 2-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Makinouchi in view of Isobe et al. (2003/0218169).

Makinouchi disclose the subject matter claimed above, including the use of the mask in the formation of circuit patterns, however Makinouchi does not disclose specifically using the mask in the formation of data lines, pixel electrodes and thin film transistors.

Referring to claim 2, Isobe et al. disclose a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light (para. 29 & 92). Isobe et al. further disclose wherein the pattern formed on the substrate is electrically coupled with a conductive pattern (111) disposed in a different layer from the pattern to generate a coupling capacitance, wherein an insulation layer (110) is disposed between the pattern and the conductive pattern (111) (para 87-90).

Referring to claim 3, Isobe et al. disclose wherein the pattern formed on the substrate corresponds to a data line (para. 90-92).

Referring to claim 4, Isobe et al. disclose forming an insulation layer (615) on the substrate having the data line; and forming a pixel electrode (670) as a conductive pattern on the substrate having the insulation layer (615), wherein a direction of scanning is substantially perpendicular to a longitudinal direction of the data line during an exposure process for forming the pixel electrode (670) (para. 29 & 159-163).

Since Makinouchi and Isobe et al. are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Isobe et al. would have been recognized in the pertinent art of Makinouchi Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Makinouchi by using the mask in the formation of data lines and pixel electrodes as taught by Isobe et al. to prevent the lowering of the mobility of the thin film transistor (para. 20).

Claims 5, 6 and 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Makinouchi in view of Isobe et al. as applied to claim 1 above, and further in view of Kim (2003/0211404).

Makinouchi in view of Isobe et al. disclose the subject matter claimed above except the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask.

Kim discloses a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light to form a pattern (para. 17 & 18). Kim further discloses the substrate having a size of more than or equal to seventeen inches, wherein the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches (para. 10 and 14-16). Kim also discloses exposing one pattern (cell) using the mask (Fig. 4; para. 41).

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Since Makinouchi and Kim are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Kim would have been recognized in the pertinent art of Makinouchi. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Makinouchi by the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask as taught by Kim to increase the surface area of the liquid crystal display.

Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over Makinouchi in view of Isobe et al. as applied to claim 1 above, and further in view of Tanuma et al. (5,718,839).

Makinouchi in view of Isobe et al. disclose the subject matter claimed above except an interval between the data line and a pixel electrode formed on the substrate being at least 6.25 μ m.

Tanuma et al. disclose a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light to form a pattern (Fig. 20b; col. 26, lines 39-54). Tanuma et al. further disclose an interval between the data line and a pixel electrode formed on the substrate is 10 μ m or less (col. 8, lines 40-56).

Since Makinouchi and Tanuma et al. are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Tanuma et al. would have been recognized in the pertinent art of Makinouchi Therefore, it would have been

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obvious to one of ordinary skill in the art at the time the invention was made to modify Makinouchi by an interval between the data line and a pixel electrode formed on the substrate being 10 μ m or less as taught by Tanuma et al. to prevent abnormalities in the liquid crystals (col. 8, lines 40-56).

Claims 9, 14, 15, 19 and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yang et al. (2003/0213966) in view of Makinouchi

Yang et al. disclose a method for the formation of circuit patterns where a gate wiring layer is formed on a substrate (10); etching the gate wiring layer to form a gate wiring that includes a gate line (22), a gate pad (end) (24) and a gate electrode (26) (para. 235); forming a gate insulation layer (30) on the substrate (10) having the gate wiring formed on the substrate (10) (para. 236); forming a semiconductor layer pattern (40) and an ohmic contact layer pattern (50) on the gate insulation layer (30) in sequence (para. 236 & 237); forming a data wiring layer on the substrate (10) having the semiconductor layer pattern (40) and the ohmic contact layer pattern (50); forming a photoresist layer on the data wiring layer; disposing a mask including a pattern shape over the photoresist layer formed on the substrate (10); the mask with a light, such that a direction of the scanning is patterning the data wiring layer to form a data wiring including a data line (62) crossing the gate line (22), a data pad (end) (68) connected to the data line (62), a source electrode (65) connected to the data line (62), and a drain electrode (66) in an opposite position to the source electrode (65) around the gate electrode(26) (para. 237 & 238); forming a protection layer (70) on the substrate (10)

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having the source and drain electrodes (65 &66) formed thereon; patterning the gate insulation layer (30) and the protection layer (70) to form contact holes (72, 74, 76, 78), the contact holes exposing the gate pad (end) (24), the data pad (end) (68) and the drain electrode (66), respectively (para. 239); forming a transparent conductive layer; and etching the transparent conductive layer to form an supplementary gate pad (auxiliary gate end) (84) being electrically connected to the gate pad (end) (24), a(n) supplementary data pad (auxiliary data end) (88) being electrically connected to the data pad (end) (68), and a pixel electrode (84) being electrically connected to the drain electrode (66) (para. 239 & 240). Yang et al. further disclose the photosensitive layer pattern including a first portion, a second portion thicker than the first portion, and a third portion thinner than the first portion (para. 140; claim 75). Yang et al. also disclose wherein the first portion is positioned between the source electrode and the drain electrode, and the second portion is positioned over an upper portion of the data wiring (para. 140).

Yang et al. do not disclose scanning substantially perpendicular to a longitudinal direction of the pattern shape to expose the photoresist layer.

Makinouchi disclose a method for exposing a layer with a light where a mask including a pattern shape is disposed over the layer formed on a substrate; and scanning the mask with the light, such that a direction of the scanning is substantially perpendicular to a longitudinal direction of the pattern shape to form a pattern (Fig. 1 & 2a; col. 3, lines 4-20; col. 5, lines 15-39; col. 7, lines 34-48).

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Since Yang et al. and Makinouchi are both from the same field of endeavor, a method for the formation of circuit patterns, the purpose disclosed by Makinouchi would have been recognized in the pertinent art of Yang et al. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Yang et al. by canning substantially perpendicular to a longitudinal direction of the pattern shape to expose the photoresist layer as taught by Makinouchi to prevent deviation from the pattern (col. 2, lines 29-57).

Referring to claim 21, Makinouchi discloses wherein the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device (col. 1. lines 13-30).

Claims 11, 12 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yang et al. in view of Makinouchi as applied to claims 9 and 14 above, and further in view of Tanuma et al.

Yang et al. in view of Makinouchi disclose the subject matter claimed above except an interval between the data line and a pixel electrode formed on the substrate being at least 6.25 μ m.

Tanuma et al. disclose a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light to form a pattern (Fig. 20b; col. 26, lines 39-54). Tanuma et al.

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further disclose an interval between the data line and a pixel electrode formed on the substrate is 10 μ m or less (col. 8, lines 40-56).

Since Yang et al. and Tanuma et al. are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Tanuma et al. would have been recognized in the pertinent art of Yang et al. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Yang et al. by an interval between the data line and a pixel electrode formed on the substrate being 10 μ m or less as taught by Tanuma et al. to prevent abnormalities in the liquid crystals (col. 8, lines 40-56).

Referring to claim 12, Makinouchi discloses wherein the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device (col. 1, lines 13-30).

Claims 13, 17 and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yang et al. in view of Makinouchi as applied to claims 9 and 14 above, and further in view of Kim.

Yang et al. in view of Makinouchi disclose the subject matter claimed above except the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask.

Kim discloses a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask

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with the light to form a pattern (para. 17 & 18). Kim further discloses the substrate having a size of more than or equal to seventeen inches, wherein the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches (para. 10 and 14-16). Kim also discloses exposing one pattern (cell) using the mask (Fig. 4; para. 41).

Since Yang et al. and Kim are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Kim would have been recognized in the pertinent art of Yang et al. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Yang et al. by the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask as taught by Kim to increase the surface area of the liquid crystal display.

Referring to claim 18, Kim discloses simultaneously exposing a plurality of cells using the mask (Fig. 5A; para. 44).

Claims 20, 22 and 23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yang et al. in view of Makinouchi as applied to claim 9 above, and further in view of Kim.

Yang et al. in view of Makinouchi disclose the subject matter claimed above except the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask.

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Kim discloses a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light to form a pattern (para. 17 & 18). Kim further discloses the substrate having a size of more than or equal to seventeen inches, wherein the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches (para. 10 and 14-16). Kim also discloses exposing one pattern (cell) using the mask (Fig. 4; para. 41).

Since Yang et al. and Kim are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Kim would have been recognized in the pertinent art of Yang et al. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Yang et al. by the substrate corresponds to a substrate of a patterned vertical alignment mode liquid crystal display device having a size of nineteen inches and one cell is exposed by the mask as taught by Kim to increase the surface area of the liquid crystal display.

Claim 24 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yang et al. in view of Makinouchi as applied to claim 9 above, and further in view of Tanuma et al. (5,718,839).

Yang et al. in view of Makinouchi disclose the subject matter claimed above except an interval between the data line and a pixel electrode formed on the substrate being at least 6.25 μ m.

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Tanuma et al. disclose a method for exposing a layer with a light where a mask including a pattern shape is formed over the layer formed on a substrate; and scanning the mask with the light to form a pattern (Fig. 20b; col. 26, lines 39-54). Tanuma et al. further disclose an interval between the data line and a pixel electrode formed on the substrate is $10 \ \mu m$ or less (col. 8, lines 40-56).

Since Yang et al. and Tanuma et al. are both from the same field of endeavor, a method for exposing a layer with a light, the purpose disclosed by Tanuma et al. would have been recognized in the pertinent art of Yang et al. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Yang et al. by an interval between the data line and a pixel electrode formed on the substrate being $10 \ \mu m$ or less as taught by Tanuma et al. to prevent abnormalities in the liquid crystals (col. 8, lines 40-56).

Zandra V. Smith

Zandra V. Ottomory Patent Examiner

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